

FACSIMILE TRANSMISSION TO
THE UNITED STATES PATENT AND TRADEMARK OFFICE

DATE: 10/23/2003

RE: Serial No.: 10/005689

Docket No.: US01 8180

TO: Examiner: Nguyen, Trung

Art Unit: 2829

Fax Number: (703) 872-9318

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FROM: Michael J. Ure, Reg. No. 33.089

Telephone: (408) 474 - 9077

TRANSMISSION INCLUDES: 4 Pages (including cover sheet)

Response to Office Action Dated 08/29/2003 - 3 pages

CERTIFICATE OF TRANSMISSION UNDER 37 CFR 1.8	
I hereby certify that this correspondence is being facsimile transmitted to the Patent and Trademark Office at the number listed above	
on 10/23, 2003	by Daniel W. McDonald

PHILIPS ELECTRONICS NORTH AMERICA CORPORATION
Intellectual Property & Standards
1109 McKay Drive M/S-41SJ
San Jose, California 95131
Fax Number: (408) 474-9082

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of
IVO RUTTEN

Atty. Docket
US 018180

Serial: 10/005,689

Group Art Unit: 2829

Filed: 11/08/2001

Examiner: NGUYEN, TRUNG Q.

CHIP-MOUNTED CONTACT SPRINGS

Commissioner of Patents
P.O. Box 1450
Alexandria, VA 22313-1450

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RESPONSE UNDER 37 C.F.R. 1.111

Sir:

The following Remarks are responsive to the Office Action of 08/29/2003.

REMARKS

The Office Action of 08/29/2003 has been carefully considered. Reconsideration and allowance of the present application in view of the present remarks is respectfully requested.

The present invention relates to an integrated circuit testing device that itself includes an integrated circuit provided with a contacting mechanism for contacting pads of the integrated circuit to be tested. Unlike "microspring" contacts characteristic of the prior art, the present invention uses V-shaped contacts formed, e.g., from a bond wire having both ends bonded to the same bond pad.